WACKER® SILICONE PASTE P 12

Silicone Pastes

Pure white, soft consistency, heat sink paste with marked thermal conductivity. Electrically insulating.

Properties

Specific features

- Thermally conductive
Technical data

General Characteristics

<table>
<thead>
<tr>
<th>Property</th>
<th>Condition</th>
<th>Value</th>
<th>Method</th>
</tr>
</thead>
<tbody>
<tr>
<td>Appearance</td>
<td>-</td>
<td>white</td>
<td>-</td>
</tr>
<tr>
<td>Bleeding (at 200°C/30h)</td>
<td>-</td>
<td>max. 0.4 %</td>
<td>FED-STD 791 M 321</td>
</tr>
<tr>
<td>Density</td>
<td>23 °C</td>
<td>2.1 g/cm³</td>
<td>DIN EN ISO 1183-1 A</td>
</tr>
<tr>
<td>Dielectric strength</td>
<td>-</td>
<td>10 kV/mm</td>
<td>IEC 60243-1</td>
</tr>
<tr>
<td>Dissipation factor</td>
<td>50 Hz</td>
<td>9 x 10⁻³</td>
<td>IEC 62631-2-1</td>
</tr>
<tr>
<td>Loss of weight⁽¹⁾</td>
<td>-</td>
<td>max. 1.2 %</td>
<td>FED-STD 791 M 321</td>
</tr>
<tr>
<td>Operating temperature range</td>
<td>-</td>
<td>-40 - 200 °C</td>
<td>-</td>
</tr>
<tr>
<td>Penetration (unworked)⁽²⁾</td>
<td>-</td>
<td>270 - 300 1/10mm</td>
<td>DIN ISO 2137</td>
</tr>
<tr>
<td>Permittivity</td>
<td>50 Hz</td>
<td>3.5</td>
<td>IEC 62631-2-1</td>
</tr>
<tr>
<td>Solidifying point</td>
<td>-</td>
<td>approx. -45 °C</td>
<td>-</td>
</tr>
<tr>
<td>Thermal conductivity</td>
<td>-</td>
<td>0.6 - 0.8 W/m.K</td>
<td>ASTM D 5470-12</td>
</tr>
</tbody>
</table>

⁽¹⁾30h / 200 °C
⁽²⁾150g cone / 5s penetration time

These figures are only intended as a guide and should not be used in preparing specifications.

All the information provided is in accordance with the present state of our knowledge. Nonetheless, we disclaim any warranty or liability whatsoever and reserve the right, at any time, to effect technical alterations. The information provided, as well as the product’s fitness for an intended application, should be checked by the buyer in preliminary trials. Contractual terms and conditions always take precedence. This disclaimer of warranty and liability also applies particularly in foreign countries with respect to third parties’ rights.

Applications

- Encapsulation
- Antifriction Agents & Lubricants
Application details

WACKER® SILICONE PASTE P 12 is used especially in semiconductor technology as a heat sink paste. Wherever it is important to have good heat transfer from a semiconductor to a cooling element, it is advisable to apply a thin coating of WACKER® SILICONE PASTE P 12. In the assembly of semiconductors, e.g., diodes, transistors and thyristors, microscopic irregularities may exist on the mating surfaces of the semiconductor and the cooling surface. When assembled, a firm metal-to-metal contact might be hampered by these surface irregularities. A significant percentage of the device’s surface therefore might lack direct contact to the heatsink. Remaining gaps are filled with air, providing relatively poor thermal conductivity.

By coating the contact surfaces with WACKER® SILICONE PASTE P 12, surface irregularities will be filled with the heat sink silicone paste. The thermal conductivity of WACKER® SILICONE PASTE P 12 is about 20 times better than that of air. Practical experience has shown that by using WACKER® SILICONE PASTE P 12, the heat transfer resistance from the semiconductor housing to the cooling elements is reduced by 50%.

WACKER® SILICONE PASTE P 12 can be applied with a brush, spatula or by screen printing. Best results are achieved when a uniform, thin coating is applied to the mating surfaces. Excess paste that’s squeezed during assembly should be removed.

For detailed information, refer to brochures on www.wacker.com.

Packaging and storage

Storage

Store in a dry and cool place.
The ‘Best use before end’ date of each batch is shown on the product label.
Storage beyond the date specified on the label does not necessarily mean that the product is no longer usable. In this case however, the properties required for the intended use must be checked for quality assurance reasons.

Safety notes

Comprehensive instructions are given in the corresponding Material Safety Data Sheets. They are available on request from WACKER subsidiaries or may be printed via WACKER web site http://www.wacker.com.

QR Code WACKER® SILICONE PASTE P 12

For technical, quality or product safety questions, please contact:

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